

Vishay General Semiconductor

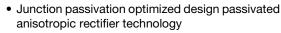
Surface Mount PAR® Transient Voltage Suppressors

High Temperature Stability and High Reliability Conditions



PRIMARY CHARACTERISTICS				
V_{BR}	27 V			
P _{PPM} (10 x 1000 μs)	6600 W			
P_{D}	8 W			
V_{WM}	22 V			
I _{RSM}	130 A			
I _{FSM}	700 A			
T _J max.	175 °C			
Polarity	Uni-directional			
Package	DO-218AB			

FEATURES





• T_{.1} = 175 °C capability suitable for high reliability and automotive requirement

RoHS

· Low leakage current

- Low forward voltage drop
- · High surge capability
- Meets ISO7637-2 surge specification
- · Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C
- AEC-Q101 qualified
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

Use in sensitive electronics protection against voltage transients induced by inductive load switching and lighting, especially for automotive load dump protection application.

MECHANICAL DATA

Case: DO-218AB

Molding compound meets UL 94 V-0 flammability rating Base P/NHE3 - RoHS-compliant, AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

HE3 suffix meets JESD 201 class 2 whisker test

Polarity: Heatsink is anode

MAXIMUM RATINGS (T _C = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	VALUE	UNIT		
Peak pulse power dissipation with 10/1000 µs waveform	P _{PPM}	6600	W		
Power dissipation on infinite heatsink at T _C = 25 °C (fig. 1)	P _D	8.0	W		
Non-repetitive peak reverse surge current for 10 µs/10 ms exponentially decaying waveform	I _{RSM}	130	А		
Maximum working stand-off voltage	V_{WM}	22.0	V		
Peak forward surge current 8.3 ms single half sine-wave	I _{FSM}	700	Α		
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +175	°C		

ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)					
DEVICE TYPE BREAKDOWN VOLTAGE V _{BR} AT I _T (V)		TEST CURRENT I _T (mA)	STAND-OFF VOLTAGE V _{WM}		
	MIN.	MAX.	(IIIA)	(V)	
SM8A27	24	30	10	22	



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ADDITIONAL CHARACTERISTICS (T _C = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Zener voltage temperature coefficient	I _Z = 10 mA	V_{ZTC}	-	-	36	mV/°C
Clamping voltage for 10 µs/10 ms exponentially decaying waveform	I _{PP} = 75 A	V _C	-	-	40.0	V
Instantaneous forward voltage	$I_F = 6.0 \text{ A}$	V _F ⁽¹⁾	-	-	0.98	V
Instantaneous forward voltage	I _F = 100 A		-	0.93	-	
Reverse leakage current	$T_J = 25 ^{\circ}\text{C}$	- I _R	ı	-	1.0	- μΑ
	Rated V_{WM} $T_J = 175 ^{\circ}\text{C}$		-	-	50.0	

Note

 $^{^{(1)}}$ Measured on a 300 μs square pulse width

THERMAL CHARACTERISTICS (T _C = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	VALUE	UNIT	
Typical thermal resistance, junction to case	$R_{ heta JC}$	0.90	°C/W	

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
SM8A27HE3/2D ⁽¹⁾	2.605	2D	750	13" diameter plastic tape and reel, anode towards the sprocket hole

Note

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25$ °C unless otherwise noted)

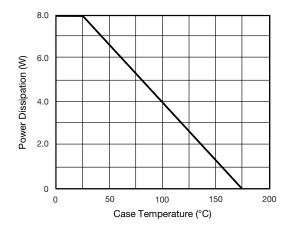


Fig. 1 - Power Derating Curve

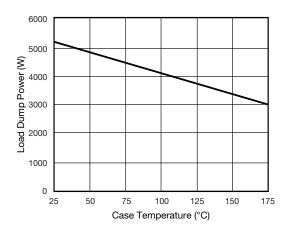


Fig. 2 - Load Dump Power Characteristics (10 ms Exponential Waveform)

⁽¹⁾ AEC-Q101 qualified



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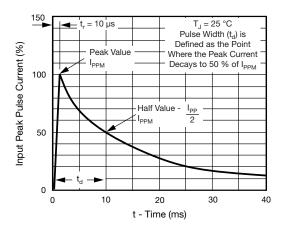


Fig. 3 - Pulse Waveform

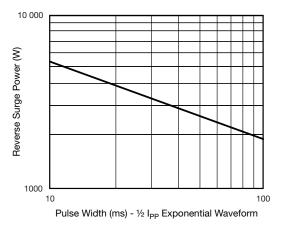


Fig. 4 - Reverse Power Capability

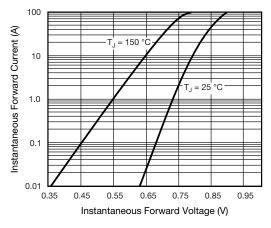


Fig. 5 - Typical Instantaneous Forward Characteristics

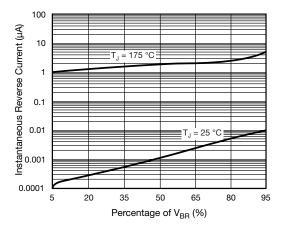


Fig. 6 - Typical Reverse Characteristics

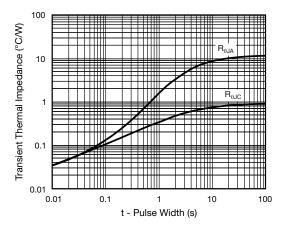
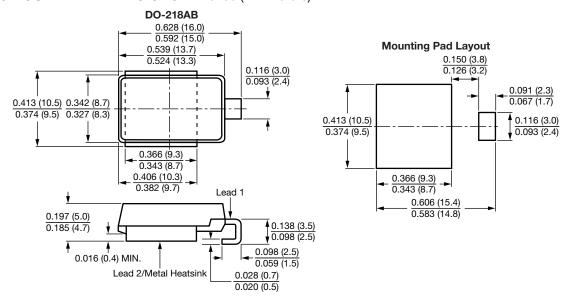


Fig. 7 - Typical Transient Thermal Impedance



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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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